

Zhen Ding Technology Holding Investor Presentation

April, 2021

2010-2020 Financial Summary

Unit: Million NTD; %

Year	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020
Revenue	34,696	44,280	55,369	64,483	75,954	85,738	82,393	109,238	117,913	120,068	131,279
Gross profit	4,638	6,993	10,775	11,894	14,323	16,427	12,542	17,833	26,061	27,222	26,584
Net income	711	2,356	4,056	5,471	6,735	7,731	3,456	6,772	11,536	12,402	11,508
Net income attributable to the parent company	711	2,356	4,056	5,471	6,735	7,731	3,456	5,172	8,448	8,685	8,095
Cash (Note 1)	1,797	4,084	8,756	10,016	23,482	31,572	30,241	33,296	49,154	43,071	46,775
Depreciation & Amortization	2,807	3,008	3,375	3,742	4,293	4,850	5,295	5,679	6,820	7,955	8,405
Capital (Note 2)	6,464	6,699	7,034	7,386	7,386	8,047	8,047	8,047	8,047	9,022	9,470
ROE	5.54%	15.34%	21.27%	23.77%	23.33%	20.82%	8.59%	14.49%	17.30%	14.72%	11.84%
Debt ratio	69.70%	67.03%	66.28%	64.06%	62.54%	53.70%	59.72%	55.33%	44.25%	35.41%	42.56%

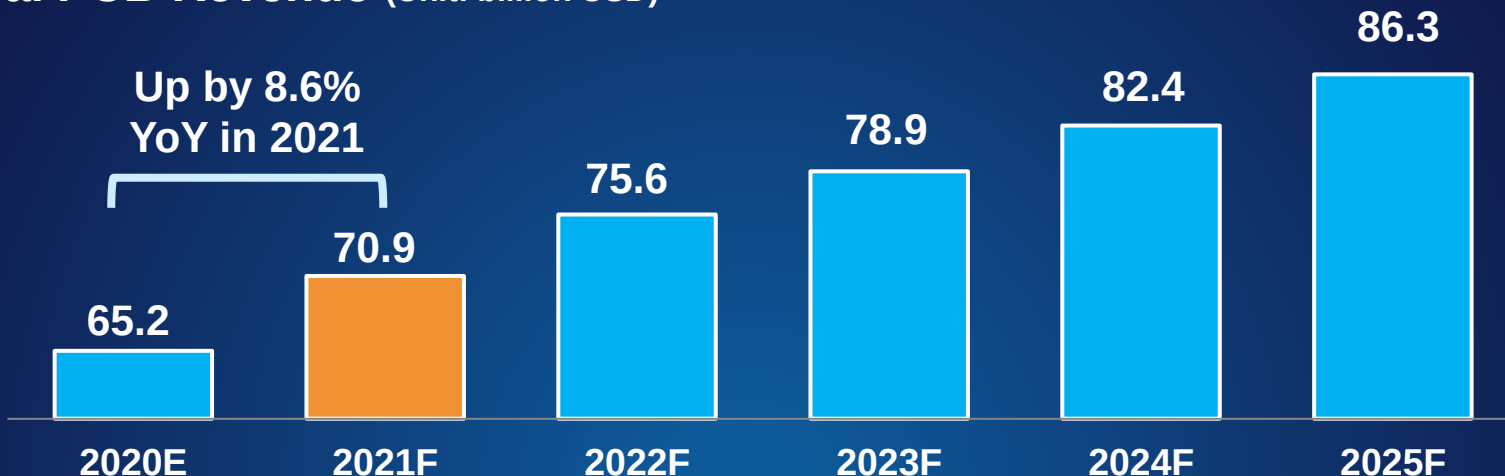
Note:

(1) Cash includes cash & cash equivalents and current financial assets at fair value through profit or loss.

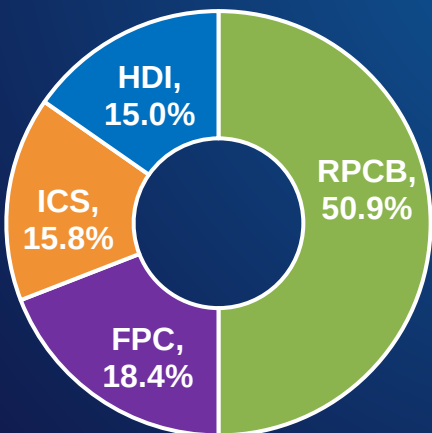
(2) The total capital increased to NTD 9,479 million as a results of the acquisition of the Boardtek by issuing new shares in November 2020.

Global PCB Market

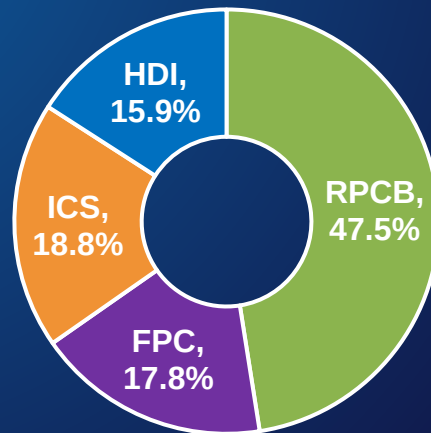
Global PCB Revenue (Unit: billion USD)



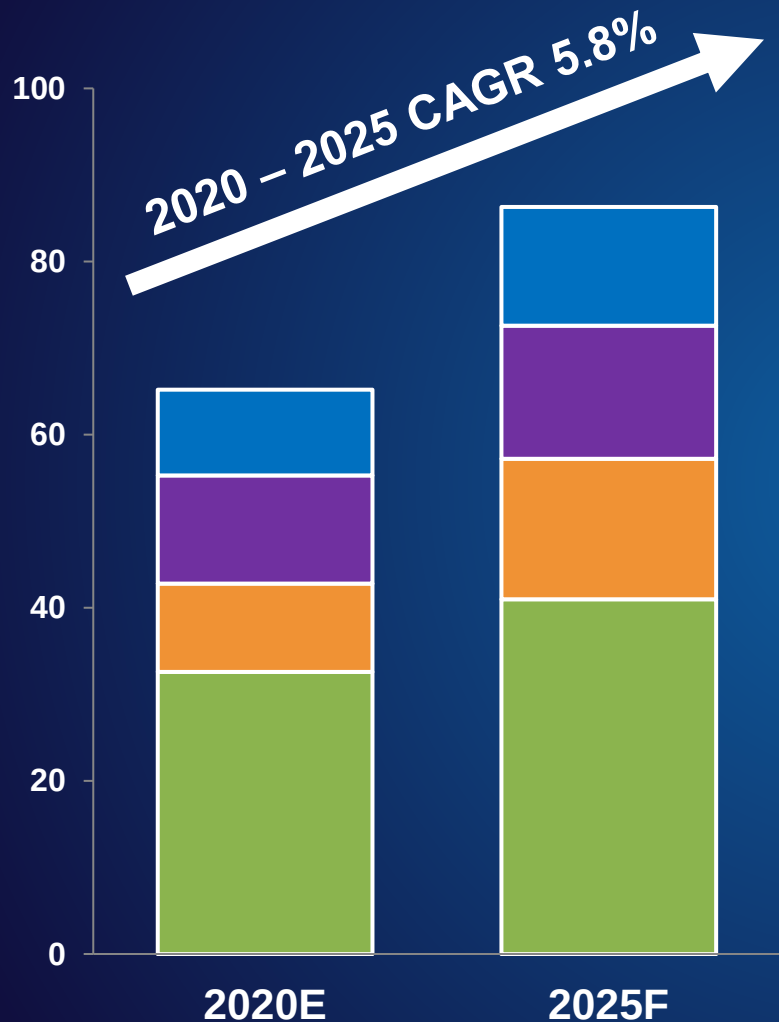
PCB Product Breakdown in 2020



PCB Product Breakdown in 2025



Global PCB Growth



PCB Products		2020 Revenue	2025 Revenue	2020-2025 CAGR
	HDI	9.9	13.7	6.7%
	FPC	12.5	15.4	4.2%
	ICS	10.2	16.2	9.7%
	RPCB	32.6	41.0	4.7%
Total		65.2	86.3	5.8%

2020

■RPCB ■ICS ■FPC ■HDI

2004



Fuyong, Shenzhen



Shenzhen Park I



Huaian Park I



Shenzhen Park II



Huaian Park II



Qinhuandao Park



Huaian Park III

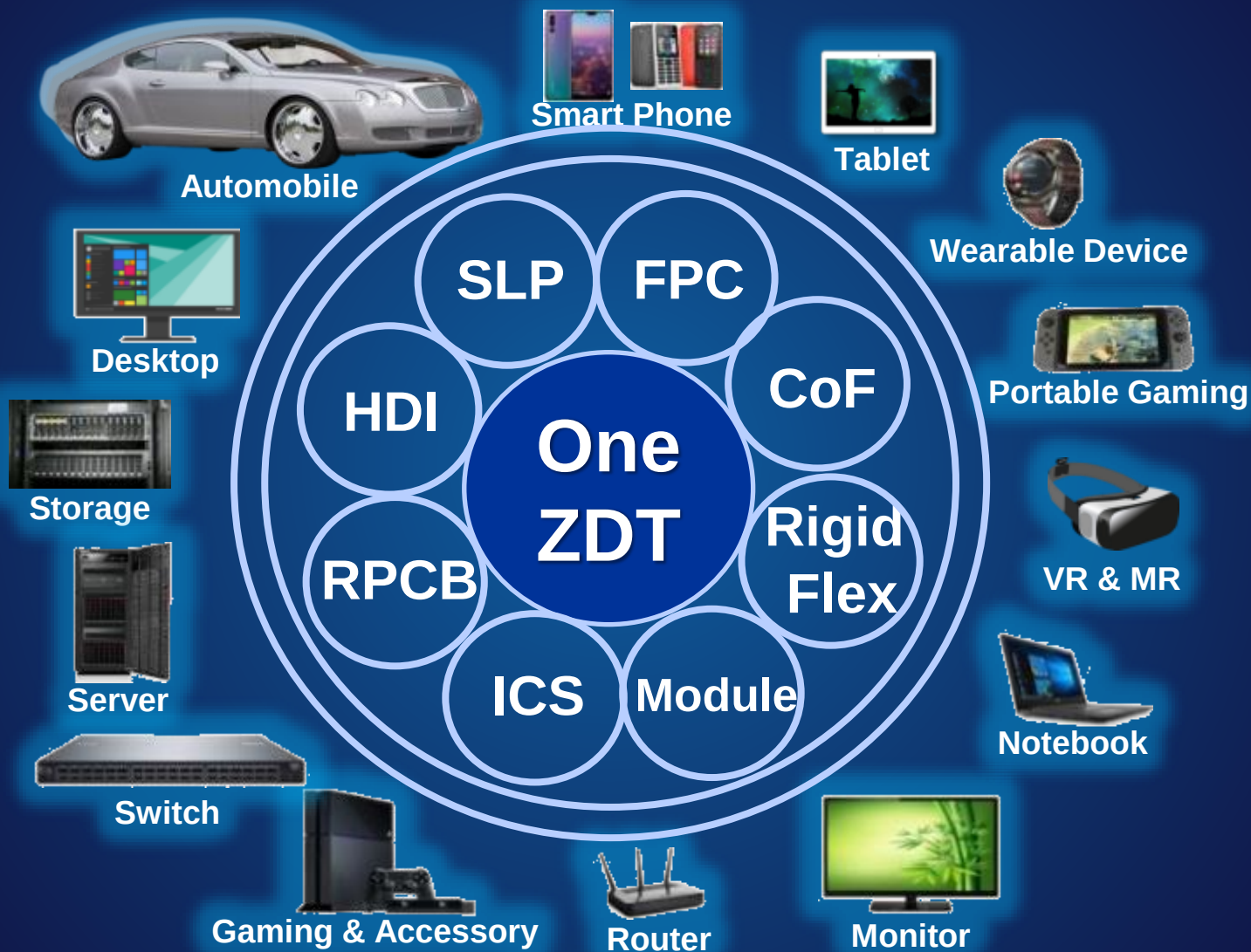


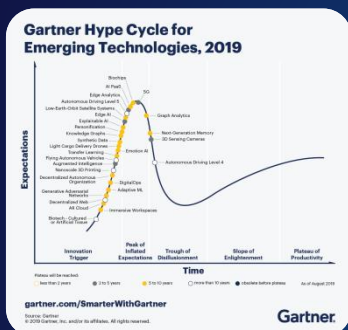
Chennai Park



Taoyuan (Boardtek)

One ZDT





**Post-Classical
Computing &
Communication**

**5G → 6G
AI
Sensing IoT**

**Augmented
Human**

**Sensing
& Mobility**

**Advanced AI
& Analytics**

**Digital
Ecosystems**



**Consumer
Electronics**



Wearable Device



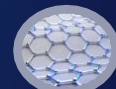
Telecommunication



**Automotive
Electronics**



**Bio
Electronics**



**Advanced
Materials**



Camera



Audio



**RF
Antenna**



**Touch
Display**



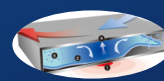
**Main
Board**



**Internet
Facility**



Cloud



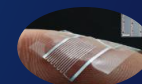
**Thermal
Management**



**Energy
& Power**

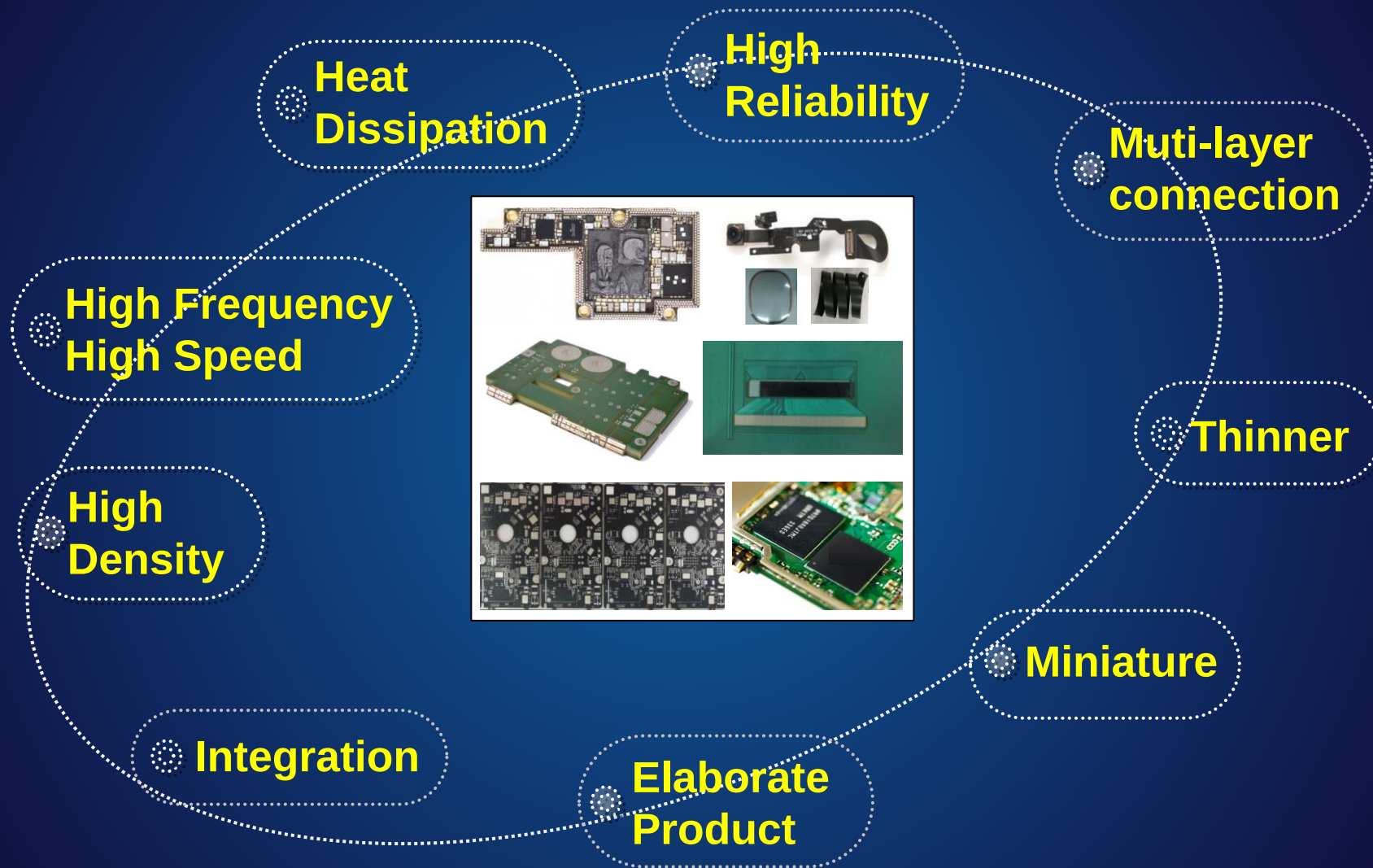


ADAS

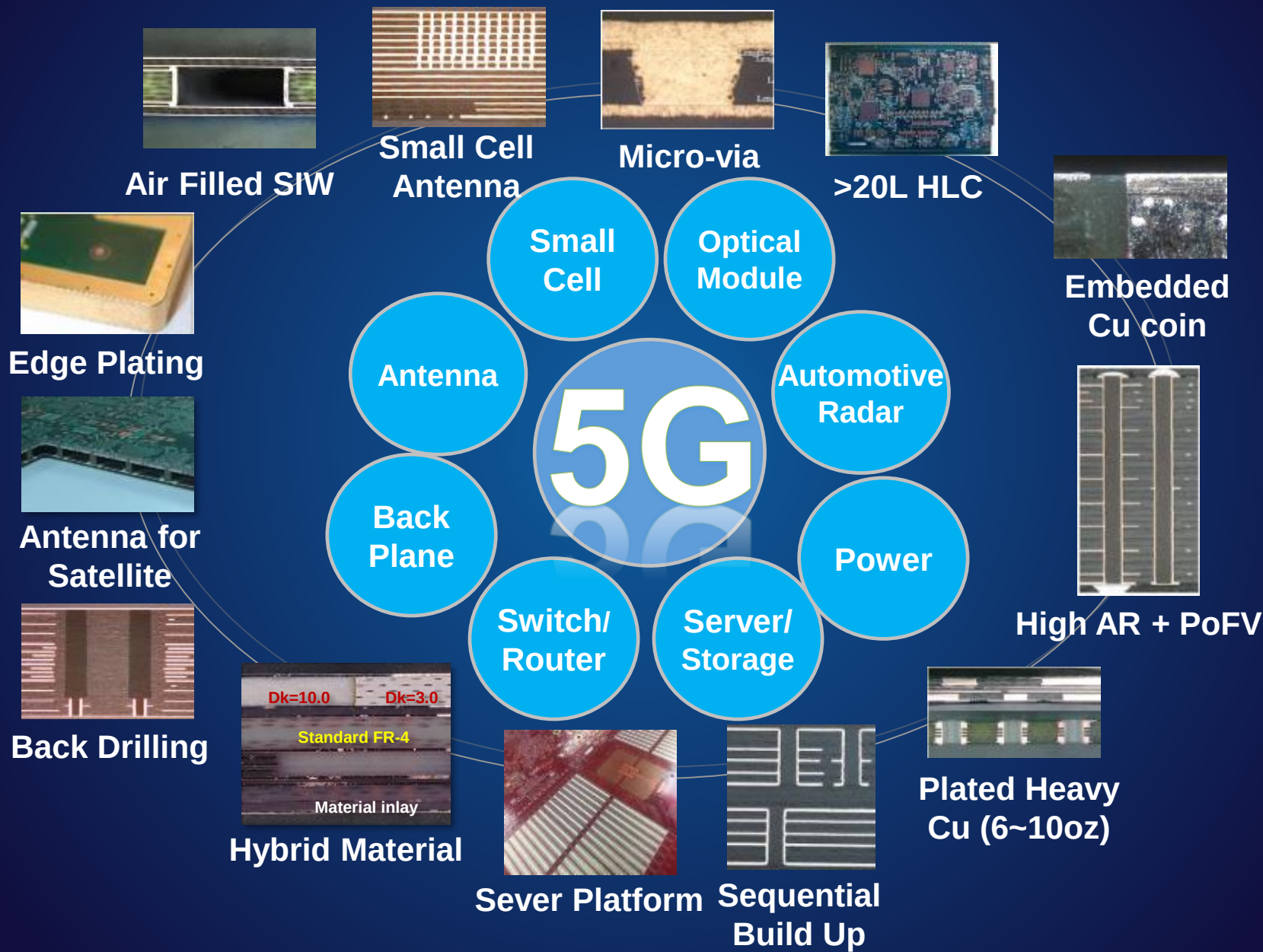


Bio Sensor

Technology Features of PCBs



5G PCB Product Portfolio

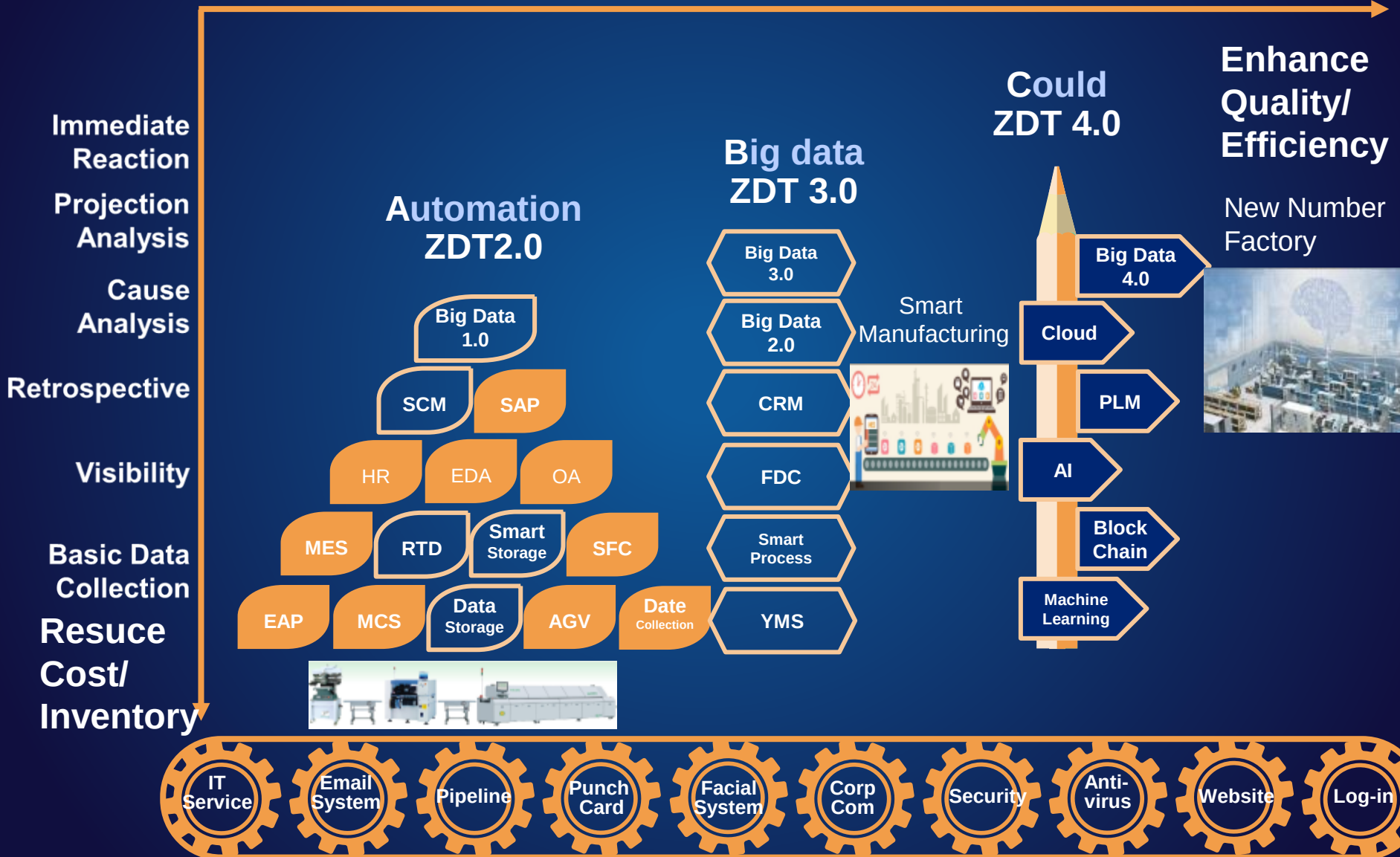


Automotive Product Portfolio



ZDT's Smart Industry 4.0

Simplification → Automative → Intelligent → Intellectual →



Q&A